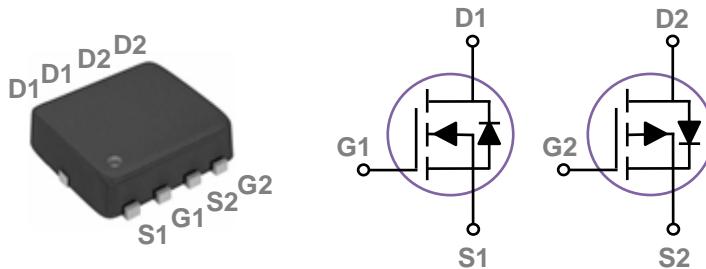


### General Description

These N+P dual Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### PPAK3X3 Dual NEP Pin Configuration



BVDSS	RDS(on)	ID
30V	20mΩ	8A
-30V	55mΩ	-4.8A

### Features

- Fast switching
- Green Device Available
- Suit for 4.5V Gate Drive Applications

### Applications

- DC Fan
- Motor Drive Applications
- Networking
- Half / Full Bridge Topology

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating		Units
$V_{DS}$	Drain-Source Voltage	30	-30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_A=25^\circ\text{C}$ )	8	-4.8	A
	Drain Current – Continuous ( $T_A=70^\circ\text{C}$ )	6.4	-3.8	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	32	-19.2	A
EAS	Single Pulse Avalanche Energy <sup>2,6</sup>	14	5	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	17	10	A
$P_D$	Power Dissipation ( $T_A=25^\circ\text{C}$ )	2		W
	Power Dissipation – Derate above $25^\circ\text{C}$	0.016		W/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150		$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150		$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62.5	$^\circ\text{C}/\text{W}$

**N-CH Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	30	---	---	V
$\text{I}_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=24\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$\text{I}_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$

**On Characteristics**

$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$ , $I_D=8\text{A}$	---	15	20	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_D=6\text{A}$	---	21	30	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D=250\mu\text{A}$	1.2	1.5	2.5	V
			---	-4	---	$\text{mV}/^\circ\text{C}$
$\text{gfs}$	Forward Transconductance	$V_{\text{DS}}=5\text{V}$ , $I_D=6\text{A}$	---	13	---	S

**Dynamic and switching Characteristics**

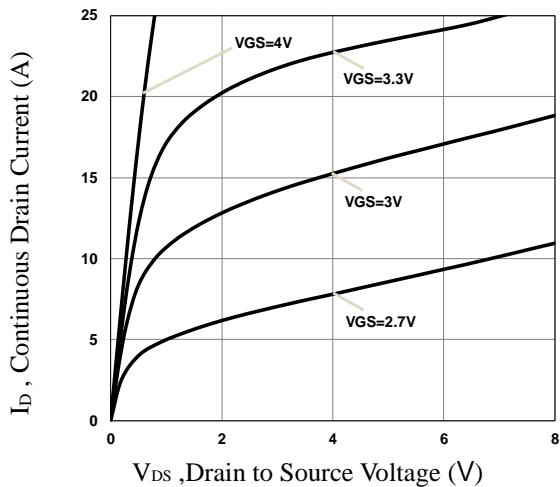
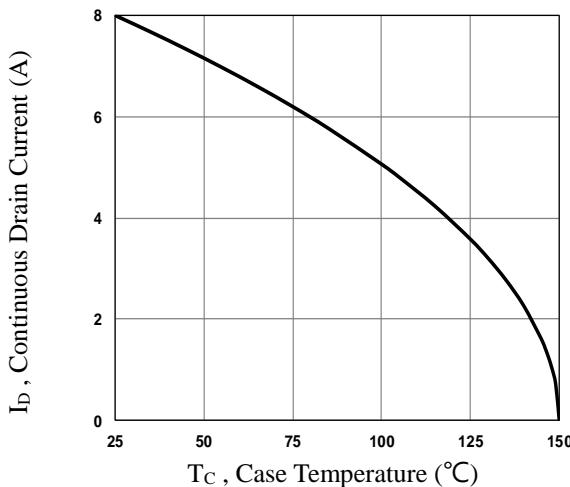
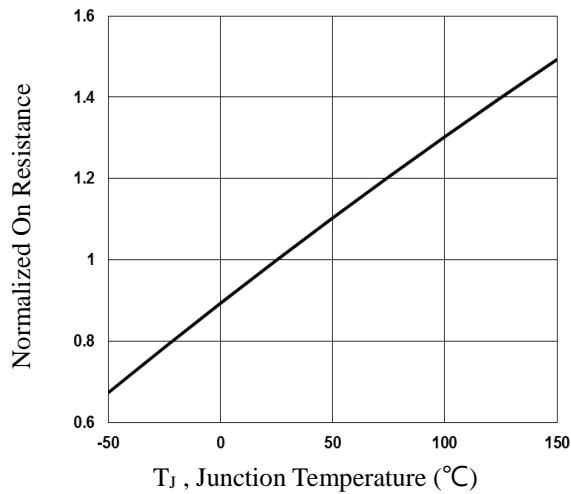
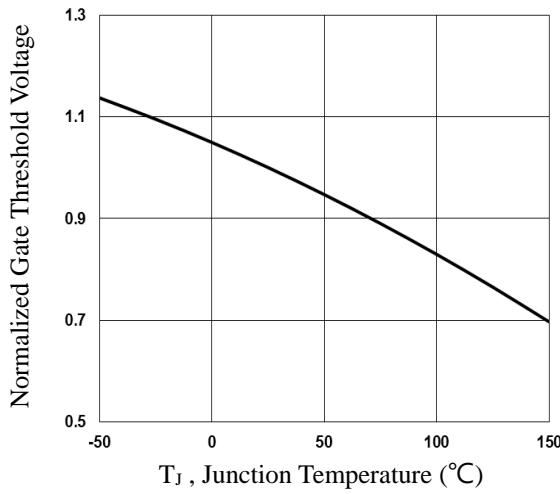
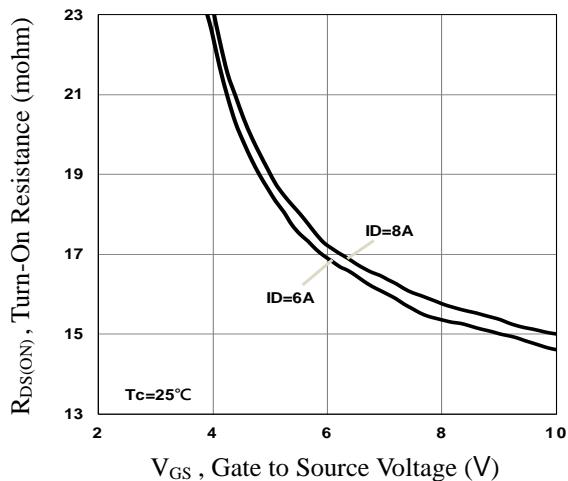
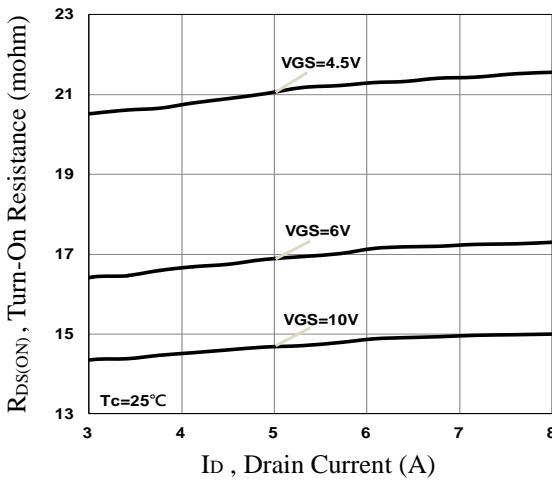
$Q_g$	Total Gate Charge <sup>3, 4</sup>	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_D=6\text{A}$	---	9.2	12	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>3, 4</sup>		---	1	1.4	
$Q_{\text{gd}}$	Gate-Drain Charge <sup>3, 4</sup>		---	2.1	4	
$T_{\text{d(on)}}$	Turn-On Delay Time <sup>3, 4</sup>	$V_{\text{DD}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_G=6\Omega$ $I_D=1\text{A}$	---	2.8	5	ns
$T_r$	Rise Time <sup>3, 4</sup>		---	7.2	14	
$T_{\text{d(off)}}$	Turn-Off Delay Time <sup>3, 4</sup>		---	15.8	30	
$T_f$	Fall Time <sup>3, 4</sup>		---	4.6	9	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	345	500	pF
$C_{\text{oss}}$	Output Capacitance		---	55	80	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	32	55	
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $F=1\text{MHz}$	---	3.2	6.4	$\Omega$

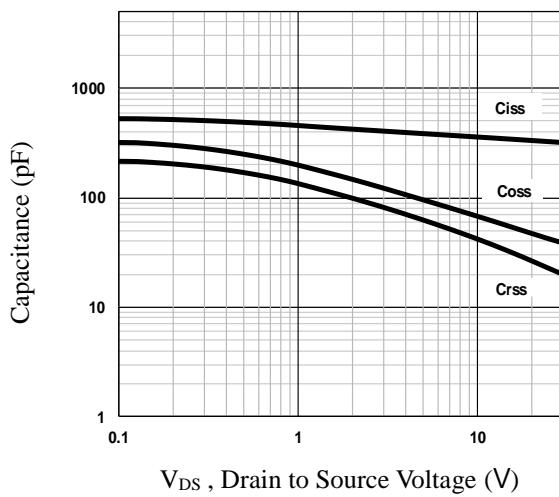
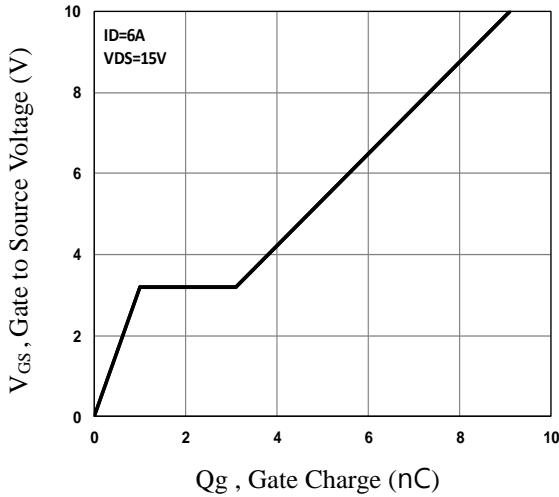
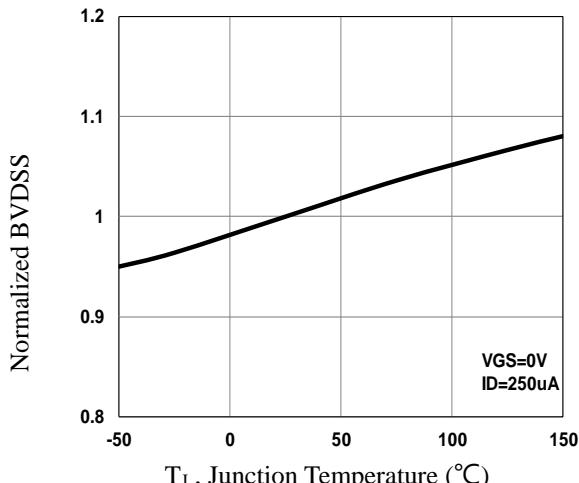
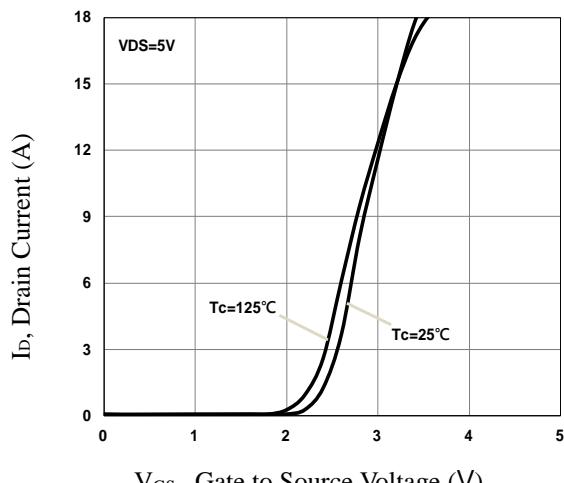
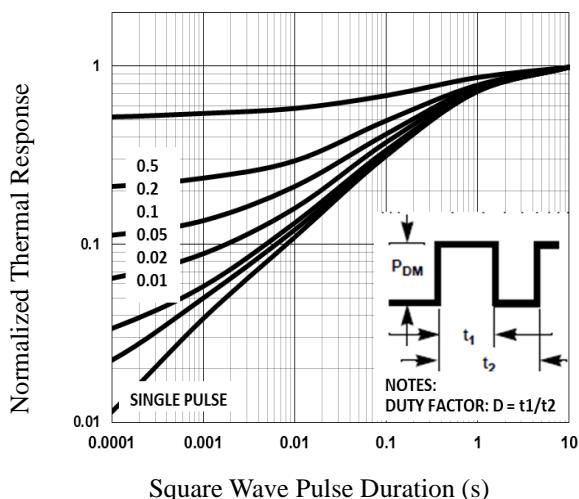
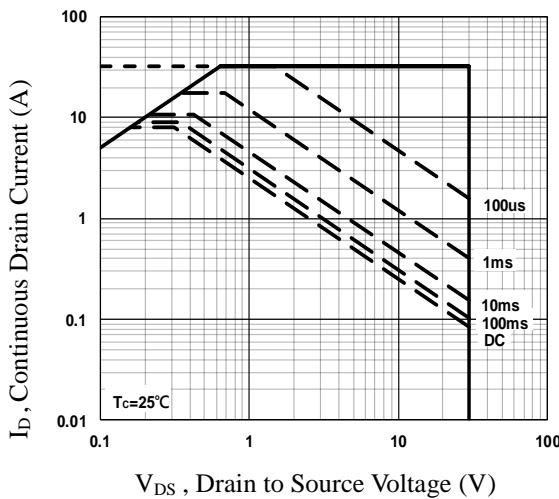
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	8	A
			---	---	16	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V
$t_{\text{rr}}$	Reverse Recovery Time	$V_R=30\text{V}$ , $I_s=4\text{A}$ $\text{di/dt}=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	110	---	ns
$Q_{\text{rr}}$	Reverse Recovery Charge		---	145	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=25\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{\text{AS}}=17\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.


**Fig.1 Typical Output Characteristics**

**Fig.2 Continuous Drain Current vs.  $T_c$** 

**Fig.3 Normalized  $R_{DSON}$  vs.  $T_j$** 

**Fig.4 Normalized  $V_{th}$  vs.  $T_j$** 

**Fig.5 Turn-On Resistance vs.  $V_{GS}$** 

**Fig.6 Turn-On Resistance vs.  $I_D$**


**Fig.7 Capacitance Characteristics**

**Fig.8 Gate Charge Characteristics**

**Fig.9 Normalized BVDSS vs.  $T_J$** 

**Fig.10 Transfer Characteristics**

**Fig.11 Normalized Transient Impedance**

**Fig.12 Maximum Safe Operation Area**

**P-CH Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=-250\mu\text{A}$	-30	---	---	V
$\text{I}_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=-30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	-1	$\mu\text{A}$
		$V_{\text{DS}}=-24\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	-10	$\mu\text{A}$
$\text{I}_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$

**On Characteristics**

$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=-10\text{V}$ , $I_D=-4\text{A}$	---	45	55	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$ , $I_D=-3\text{A}$	---	60	75	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D = -250\mu\text{A}$	-1.2	-1.6	-2.5	V
			---	4	---	$\text{mV}/^\circ\text{C}$
$\text{gfs}$	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$ , $I_D=-3\text{A}$	---	3.5	---	S

**Dynamic and switching Characteristics**

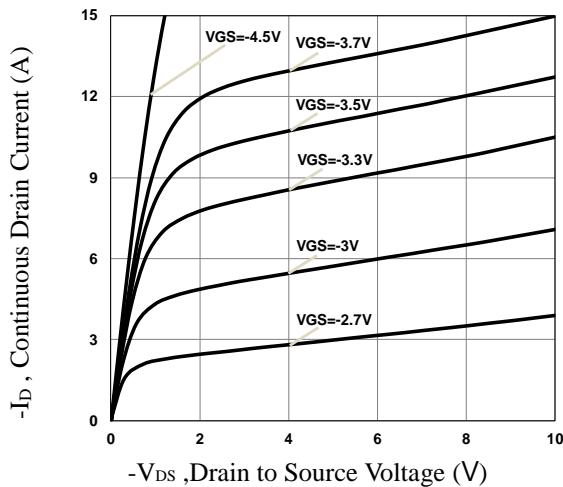
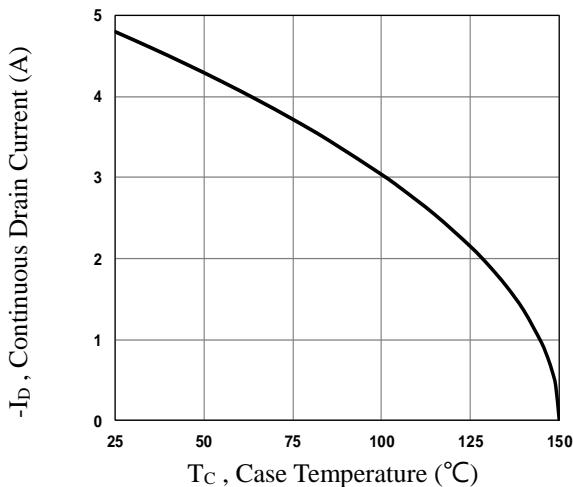
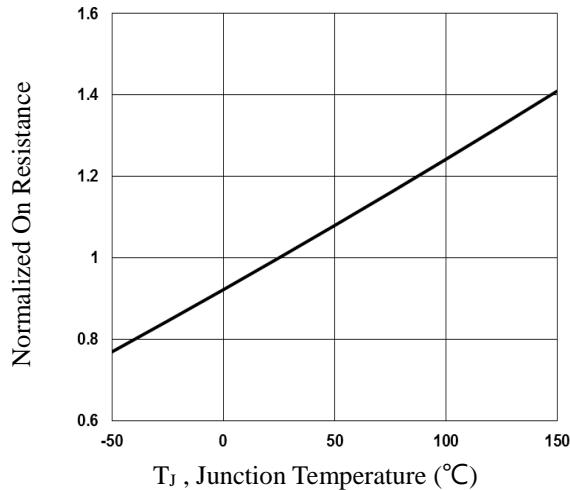
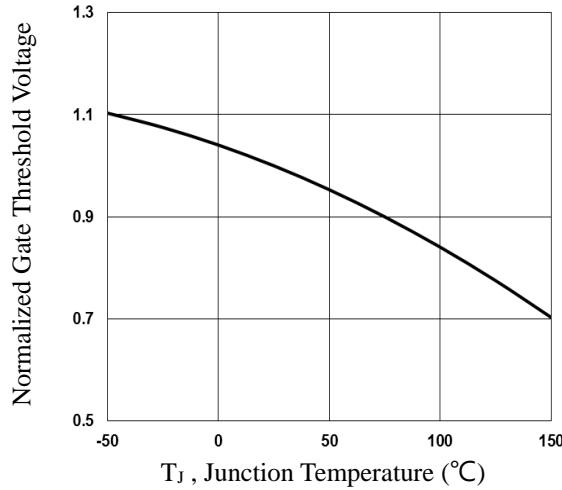
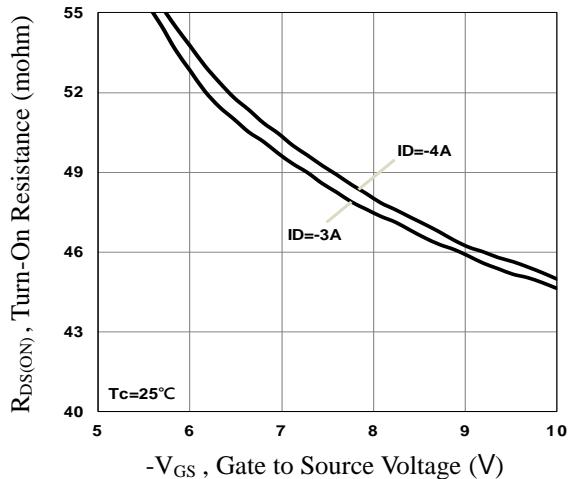
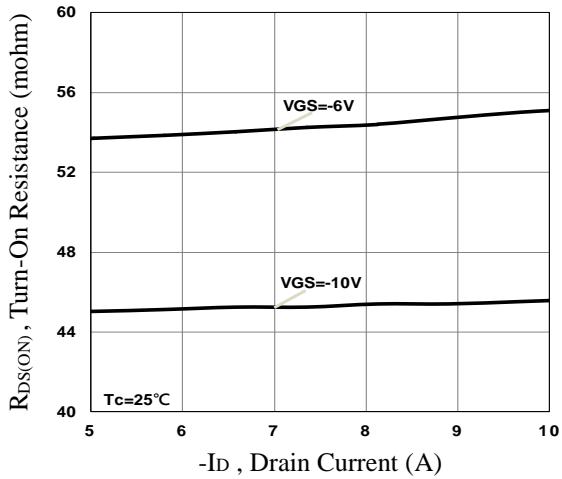
$\text{Q}_g$	Total Gate Charge <sup>7,8</sup>	$V_{\text{DS}}=-15\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $I_D=-3\text{A}$	---	11.3	7	nC
$\text{Q}_{\text{gs}}$	Gate-Source Charge <sup>7,8</sup>		---	2	3	
$\text{Q}_{\text{gd}}$	Gate-Drain Charge <sup>7,8</sup>		---	2.2	4	
$\text{T}_{\text{d(on)}}$	Turn-On Delay Time <sup>7,8</sup>	$V_{\text{DD}}=-15\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $R_G=6\Omega$	---	3.4	6	ns
$\text{T}_r$	Rise Time <sup>7,8</sup>		---	10.8	21	
$\text{T}_{\text{d(off)}}$	Turn-Off Delay Time <sup>7,8</sup>		---	26.9	51	
$\text{T}_f$	Fall Time <sup>7,8</sup>		---	6.9	13	
$\text{C}_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	560	810	pF
$\text{C}_{\text{oss}}$	Output Capacitance		---	55	80	
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance		---	40	60	

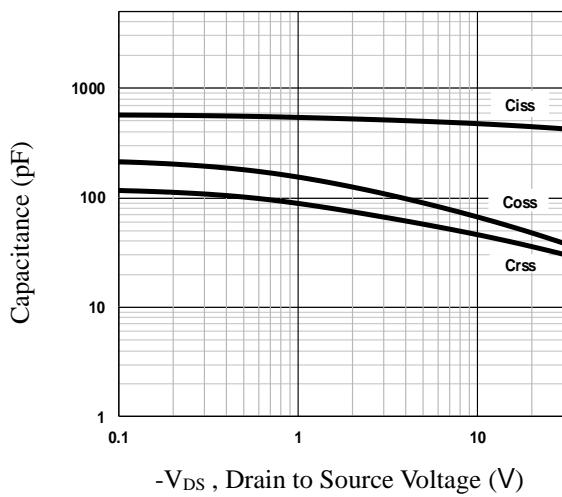
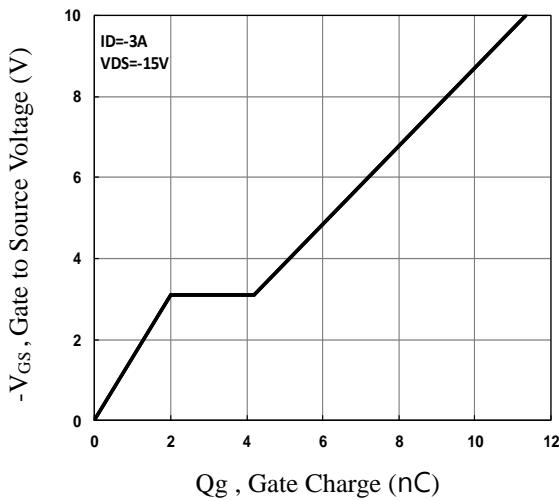
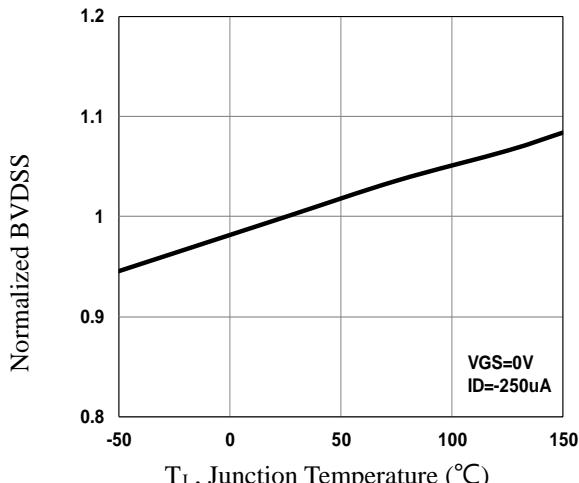
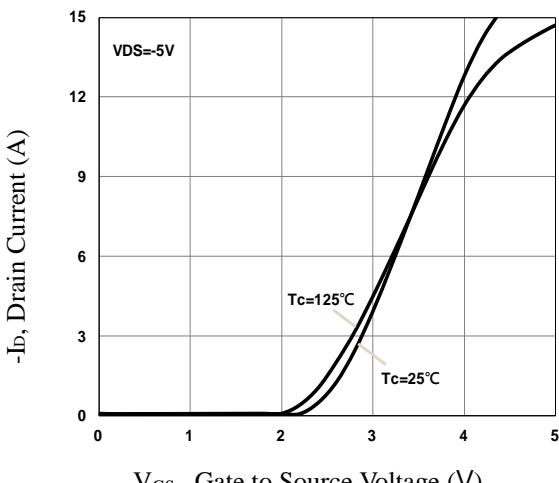
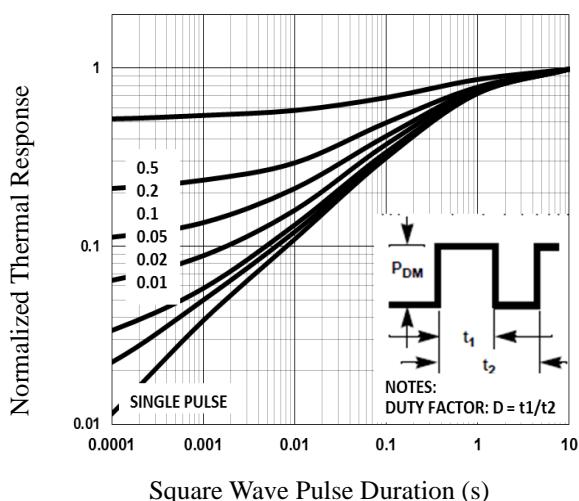
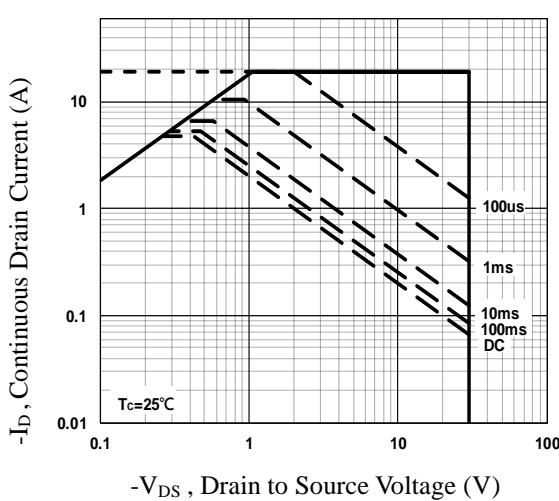
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{I}_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	-4.8	A
			---	---	-9.6	A
$\text{I}_{\text{SM}}$	Pulsed Source Current					
$\text{V}_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $\text{I}_s=-1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	-1	V
$\text{t}_{\text{rr}}$	Reverse Recovery Time	$V_R=-30\text{V}$ , $\text{I}_s=-3\text{A}$	---	155	---	ns
$\text{Q}_{\text{rr}}$	Reverse Recovery Charge	$d\text{i}/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	250	---	nC

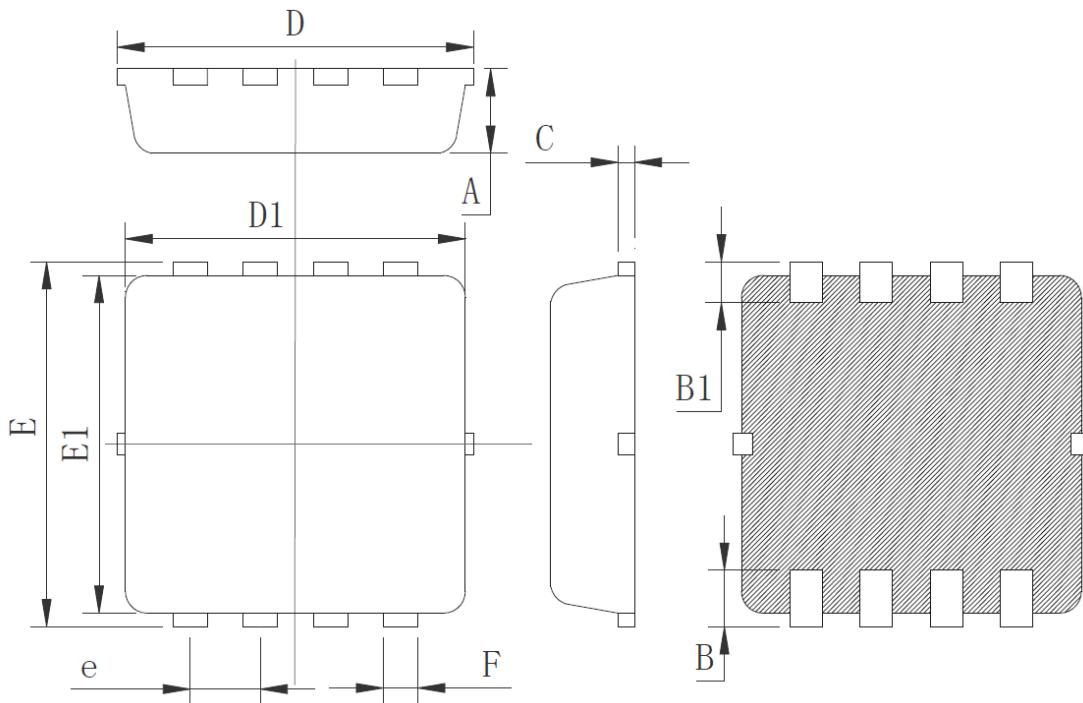
Note :

5. Repetitive Rating : Pulsed width limited by maximum junction temperature.
6.  $V_{\text{DD}}=-25\text{V}$ ,  $V_{\text{GS}}=-10\text{V}$ ,  $L=0.1\text{mH}$ ,  $\text{I}_{\text{AS}}=-10\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
7. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
8. Essentially independent of operating temperature.


**Fig.13 Typical Output Characteristics**

**Fig.14 Continuous Drain Current vs.  $T_c$** 

**Fig.15 Normalized RDSON vs.  $T_j$** 

**Fig.16 Normalized  $V_{th}$  vs.  $T_j$** 

**Fig.17 Turn-On Resistance vs.  $V_{GS}$** 

**Fig.18 Turn-On Resistance vs.  $I_D$**

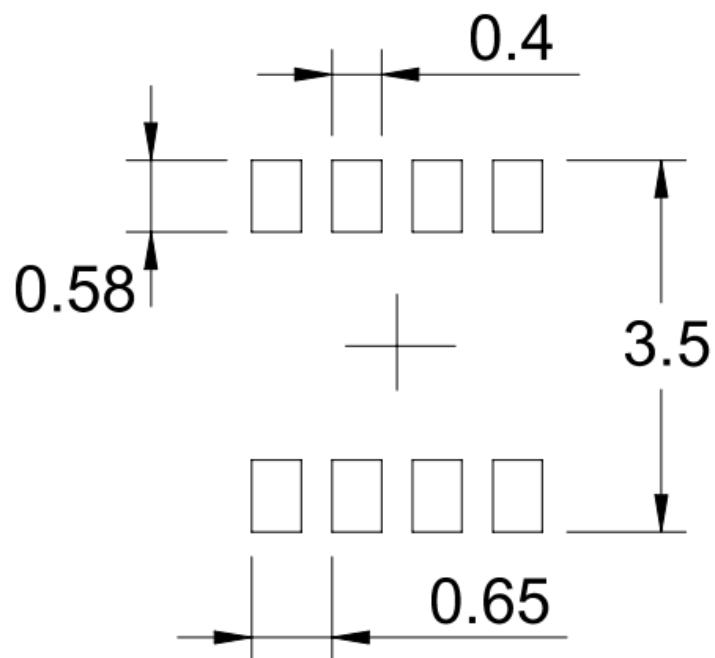

**Fig.19 Capacitance Characteristics**

**Fig.20 Gate Charge Characteristics**

**Fig.21 Normalized BVDSS vs. T<sub>J</sub>**

**Fig.22 Transfer Characteristics**

**Fig.23 Normalized Transient Impedance**

**Fig.24 Maximum Safe Operation Area**

## PPAK3x3 Dual NEP PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.725	0.825	0.029	0.032
B	0.280	0.480	0.011	0.019
B1	0.200	0.400	0.008	0.016
C	0.130	0.200	0.005	0.008
D	3.200	3.350	0.126	0.132
D1	3.050	3.250	0.120	0.128
E	3.250	3.450	0.128	0.136
E1	3.000	3.200	0.118	0.126
e	0.650 BSC		0.026 BSC	
F	0.270	0.370	0.106	0.015

## PPAK3X3 Dual NEP RECOMMENDED LAND PATTERN



unit : mm